

L Number	Hits	Search Text	DB	Time stamp
	5	HEMS and adhesive and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 10:05
	4	HEMS and adhesive and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:40
	0	HEMS and adhesive and 539/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:41
	2	HEMS and adhesive and 439/\$.ccls.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:41
	0	HEMS and adhesive and 639/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:45
	4	HEMS and adhesive and 359/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:53
	2	("5835256").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:51
	89	MEMS and adhesive and 359/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:55
	2	("6356378").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 09:55
	203	MEMS and adhesive and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 10:06
	42	MEMS and adhesive and LIQUID ADJ CRYSTAL and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 11:42
	624	transparent adj substrate and adhesive and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/05 11:44